



THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of: **Akira MATSUDA et al.**

Group Art Unit: **1775**

Application Number: **10/719,020**

Examiner: **Michael E. Lavilla**

Filed: **November 24, 2003**

Confirmation Number: **9168**

For: **PLATING BATH FOR FORMING THIN RESISTANCE LAYER,
METHOD OF FORMATION OF RESISTANCE LAYER,
CONDUCTIVE BASE WITH RESISTANCE LAYER, AND
CIRCUIT BOARD MATERIAL WITH RESISTANCE LAYER**

Attorney Docket Number: **032130**
Customer Number: **38834**

AMENDMENT

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

June 27, 2007

Sir:

This paper is filed in response to the Office Action dated March 7, 2007, the response due date extended to July 7, 2007 by a one-month Extension of Time.

Amendments to the Claims begin on page 2 of this paper.

Remarks begin on page 4 of this paper.